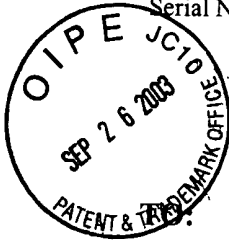


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2818



Serial Number 10/057,009

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**COMMISSIONER FOR PATENTS**  
Alexandria, VA 22313

**FROM:** Tung & Associates  
838 West Long Lake Road - Suite 120  
Bloomfield Hills, MI 48302

**DATE:** 8 April 2003

**REF:** Applicant : Chen et al. Filing Date : 24 January 2002  
Serial No : 10/057,009 Att'y No. : 64,600-095  
Art Unit : 2818 Examiner : Quoc Dinh Hoang  
Title : Micro Fabrication With Vortex Shaped Spirally Topographically  
Tapered Spirally Patterned Conductor Layer and Method for  
Fabrication Thereof

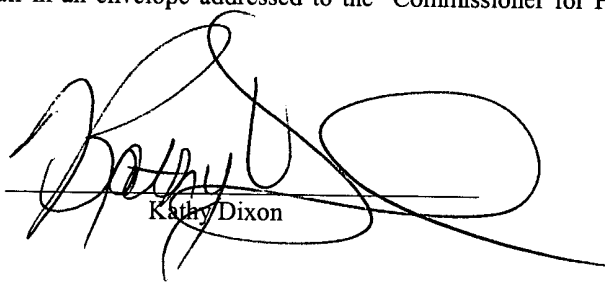
**RESPONSE TO OFFICE ACTION**

Sir:

In response to an office action mailed June 20, 2003, please enter the following amendments and consider the following remarks.

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, Alexandria, VA 22313, on September 22, 2003.

  
Kathy Dixon

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